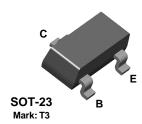


# **BSS63**



# **PNP General Purpose Amplifier**

This device is designed for general purpose amplifier and switch applications requiring high voltages. Sourced from Process 74.

## Absolute Maximum Ratings\*

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	100	V
V <sub>CBO</sub>	Collector-Base Voltage	110	V
$V_{EBO}$	Emitter-Base Voltage	6.0	V
I <sub>C</sub>	Collector Current - Continuous	200	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
3) All voltages (V) and currents (A) are negative polarity for PNP transistors.

#### **Thermal Characteristics** TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		*BSS63	
P <sub>D</sub>	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

<sup>\*</sup>Device mounted on FR-4 PCB 40 mm X 40 mm X 1.5 mm.

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## **PNP General Purpose Amplifier**

(continued)

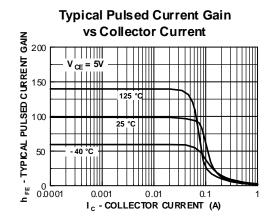
Electr	Electrical Characteristics TA = 25°C unless otherwise noted					
Symbol	Parameter	Test Conditions	Min	Max	Units	
OFF CHA	RACTERISTICS					
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	$I_C = 100  \mu A,  I_B = 0$	100		V	
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	$I_C = 10  \mu A,  I_E = 0$	110		V	
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 1.0 \mu\text{A},  I_C = 0$	6.0		V	
I <sub>CBO</sub>	Collector-Cutoff Current	$V_{CB} = 90 \text{ V}, I_E = 0$ $V_{CB} = 90 \text{ V}, I_E = 0, T_A = 150^{\circ}\text{C}$		100 50	nA μA	
I <sub>EBO</sub>	Emitter-Cutoff Current	$V_{EB} = 6.0 \text{ V}, I_{C} = 0$		200	nA	
ON CHAR	RACTERISTICS  DC Current Gain	$I_{C} = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$	30 30			
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_C = 25 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_C = 25 \text{ mA}, I_B = 2.5 \text{ mA}$	30	0.25	V	
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 25 mA, I <sub>B</sub> =2.5 mA		0.9	V	
SMALL S	IGNAL CHARACTERISTICS					
f <sub>T</sub>	Current Gain - Bandwidth Product	$I_C = 25 \text{ mA}, V_{CE} = 5.0,$ f = 35 MHz	50		MHz	

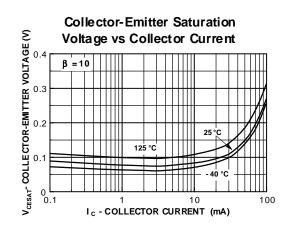
NOTE: All voltages (V) and currents (A) are negative polarity for PNP transistors.

## **Spice Model**

PNP (Is=21.48f Xti=3 Eg=1.11 Vaf=100 Bf=132.1 Ne=1.375 Is=21.48f Ikf=.1848 Xtb=1.5 Br=3.661 Nc=2 Isc=0 Ikr=0 Rc=1.6 Cjc=17.63p Mjc=.5312 Vjc=.75 Fc=.5 Cje=73.39p Mje=.3777 Vje=.75 Tr=1.476n Tf=641.9p Itf=0 Vtf=0 Xtf=0 Rb=10)

## **Typical Characteristics**

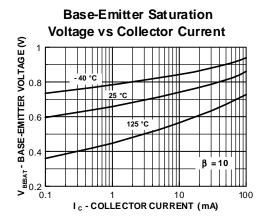


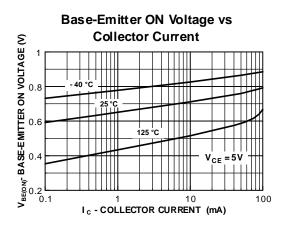


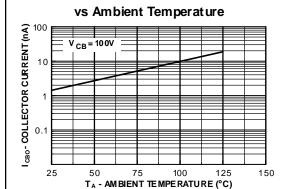
## **PNP General Purpose Amplifier**

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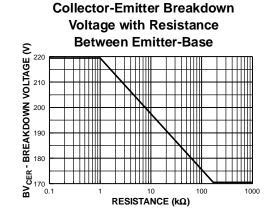
### **Typical Characteristics**

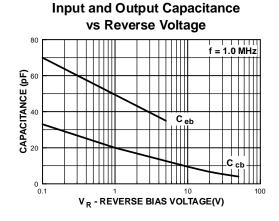


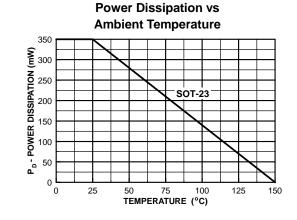




**Collector-Cutoff Current** 







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